THE DATASHEET OF

74LV1T32GWH

74LV1T32

2-input single supply translating OR gate

Rev. 5 — 14 December 2023 Product data sheet

1. General description

The 74LV1T32 is a single, level translating 2-input OR gate. The low threshold inputs support 1.8 V input logic at V_{CC} = 3.3 V and can be used in 1.8 V to 3.3 V level up translation. In addition, the 5 V tolerant input pins enable level down translation (3.3 V to 2.5 V output at V_{CC} = 2.5 V). The output level is referenced to the supply voltage and supports 1.8 V, 2.5 V, 3.3 V and 5.0 V CMOS levels. The wide V_{CC} range permits the generation of output levels to connect to controllers or processors.

2. Features and benefits

- Single supply voltage translator at 1.8 V, 2.5 V, 3.3 V and 5.0 V
- Up translation
  - 1.2 V to 1.8 V at V_{CC} = 1.8 V
  - 1.5 V to 2.5 V at V_{CC} = 2.5 V
  - 1.8 V to 3.3 V at V_{CC} = 3.3 V
  - 3.3 V to 5.0 V at V_{CC} = 5.0 V
- Down translation
  - 3.3 V to 1.8 V at V_{CC} = 1.8 V
  - 3.3 V to 2.5 V at V_{CC} = 2.5 V
  - 5.0 V to 3.3 V at V_{CC} = 3.3 V
- 5 V tolerant inputs
- Latch-up performance exceeds 250 mA per JESD 78 Class II
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Applications

- Portable applications
- PC and notebooks
- Industrial controller
- Telecom

4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LV1T32GW	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74LV1T32GV	-40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753
74LV1T32GX	-40 °C to +125 °C	X2SON5	plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 × 0.8 × 0.32 mm	SOT1226-3

5. Marking

Table 2. Marking

Type number	Marking code[1]
74LV1T32GW	SB
74LV1T32GV	SB
74LV1T32GX	SB

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

6. Functional diagram

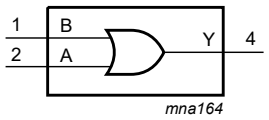


Fig. 1. Logic symbol

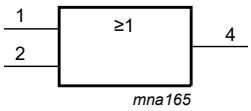


Fig. 2. IEC logic symbol

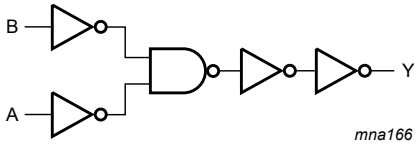


Fig. 3. Logic diagram

7. Pinning information

7.1. Pinning

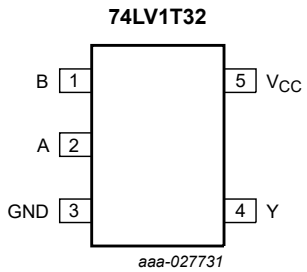
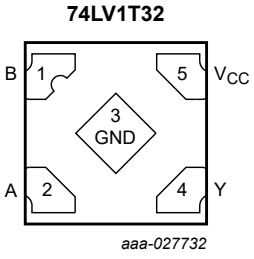


Fig. 4. Pin configuration SOT353-1 (TSSOP5) and SOT753 (SC-74A)



Transparent top view

Fig. 5. Pin configuration SOT1226-3 (X2SON5)

7.2. Pin description

Table 3. Pin description

Symbol	Pin	Description
B	1	data input
A	2	data input
GND	3	ground (0 V)
Y	4	data output
V_{CC}	5	supply voltage

8. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level.

Input		Output
A	**B**	**Y**
L	L	L
L	H	H
H	L	H
H	H	H

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+7.0	V
V_I	input voltage		[1]	-0.5	+7.0	V
V_O	output voltage	output HIGH or LOW state	[2] [3]	-0.5	V_{CC} + 0.5	V
		output in power-off state	[2]	-0.5	4.6	V
I_{IK}	input clamping current	V_I < 0 V		-20	-	mA
I_{OK}	output clamping current	V_O < 0 V or V_O > V_{CC}		-	±20	mA
I_O	output current	V_O = 0 V to V_{CC}		-	±25	mA
I_{CC}	supply current			-	50	mA
I_{GND}	ground current			-50	-	mA
T_{stg}	storage temperature			-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[4]	-	250	mW

[1] If the input current ratings are observed, the minimum input voltage ratings may be exceeded.
[2] If the output current ratings are observed, the output voltage ratings may be exceeded.
[3] This value is limited to 7 V maximum.
[4] For SOT353-1 (TSSOP5) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
For SOT753 (SC-74A) package: P_{tot} derates linearly with 3.8 mW/K above 85 °C.
For SOT1226-3 (X2SON5) package: P_{tot} derates linearly with 3.0 mW/K above 67 °C.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage		1.6	5.0	5.5	V
V_I	input voltage		0	-	5.5	V
V_O	output voltage	output HIGH or LOW state	0	-	V_{CC}	V
T_{amb}	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V_{CC} = 1.8 V to 5.0 V	-	-	20	ns/V

11. Static characteristics

Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	Min	Max	
V_{IH}	HIGH-level input voltage	V_{CC} = 1.65 V to 1.8 V	0.94	-	1.0	-	1.0	-	V
		V_{CC} = 2.0 V	0.99	-	1.03	-	1.03	-	V
		V_{CC} = 2.25 V to 2.5 V	1.135	-	1.18	-	1.18	-	V
		V_{CC} = 2.75 V	1.21	-	1.23	-	1.23	-	V
		V_{CC} = 3.0 V to 3.3 V	1.35	-	1.37	-	1.37	-	V
		V_{CC} = 3.6 V	1.47	-	1.48	-	1.48	-	V
		V_{CC} = 4.5 V to 5.0 V	2.02	-	2.03	-	2.03	-	V
		V_{CC} = 5.5 V	2.10	-	2.11	-	2.11	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 1.65 V to 2.0 V	-	0.58	-	0.55	-	0.55	V
		V_{CC} = 2.25 V to 2.75 V	-	0.75	-	0.71	-	0.71	V
		V_{CC} = 3.0 V to 3.6 V	-	0.80	-	0.65	-	0.65	V
		V_{CC} = 4.5 V to 5.5 V	-	0.80	-	0.80	-	0.80	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL};							
		V_{CC} = 1.65 V to 5.5 V; I_O = -20 µA	V_{CC} - 0.1	-	V_{CC} - 0.1	-	V_{CC} - 0.1	-	V
		V_{CC} = 1.65 V; I_O = -2 mA	1.28	-	1.21	-	1.21	-	V
		V_{CC} = 1.8 V; I_O = -2 mA	1.5	-	1.45	-	1.45	-	V
		V_{CC} = 2.3 V; I_O = -2.3 mA	2.0	-	2.0	-	2.0	-	V
		V_{CC} = 2.3 V; I_O = -3 mA	2.0	-	1.93	-	1.93	-	V
		V_{CC} = 2.5 V; I_O = -3 mA	2.25	-	2.15	-	2.15	-	V
		V_{CC} = 3.0 V; I_O = -3 mA	2.78	-	2.7	-	2.7	-	V
		V_{CC} = 3.0 V; I_O = -5.5 mA	2.6	-	2.49	-	2.49	-	V
		V_{CC} = 3.3 V; I_O = -5.5 mA	2.9	-	2.8	-	2.8	-	V
		V_{CC} = 4.5 V; I_O = -4 mA	4.2	-	4.1	-	4.1	-	V
		V_{CC} = 4.5 V; I_O = -8 mA	4.1	-	3.95	-	3.95	-	V
		V_{CC} = 5.0 V; I_O = -8 mA	4.6	-	4.5	-	4.5	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}							
		V_{CC} = 1.65 V to 5.5 V; I_O = 20 µA	-	0.1	-	0.1	-	0.1	V
		V_{CC} = 1.65 V; I_O = 2 mA	-	0.2	-	0.25	-	0.25	V
		V_{CC} = 2.3 V; I_O = 2.3 mA	-	0.1	-	0.15	-	0.15	V
		V_{CC} = 2.3 V; I_O = 3 mA	-	0.15	-	0.2	-	0.2	V
		V_{CC} = 3.0 V; I_O = 3 mA	-	0.1	-	0.15	-	0.15	V
		V_{CC} = 3.0 V; I_O = 5.5 mA	-	0.2	-	0.252	-	0.252	V
		V_{CC} = 4.5 V; I_O = 4 mA	-	0.15	-	0.2	-	0.2	V
		V_{CC} = 4.5 V; I_O = 8 mA	-	0.3	-	0.35	-	0.35	V

Symbol	Parameter	Conditions	25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	Min	Max	
I_I	input leakage current	V_I = V_{CC} or GND; V_{CC} = 0 V to 5.5 V	-	±0.1	-	±1	-	±1	µA
I_{CC}	supply current	V_I = V_{CC} or GND; I_O = 0 A; V_{CC} = 1.8 V, 2.5 V, 3.3 V, 5.0 V	-	1	-	10	-	10	µA
ΔI_{CC}	additional supply current	per input pin; V_{CC} = 1.8 V; V_I = 0.3 V or 1.1 V; I_O = 0 A; other pins at V_{CC} or GND	-	10	-	10	-	10	µA
		per input pin; V_{CC} = 5.5 V; V_I = 0.3 V or 3.4 V; I_O = 0 A; other pins at V_{CC} or GND	-	1.35	-	1.5	-	1.5	mA

12. Dynamic characteristics

Table 8. Dynamic characteristics

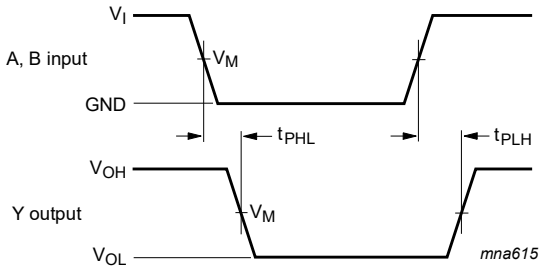
GND = 0 V. For test circuit, see Fig. 7.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t_{pd}	propagation delay	A, B to Y; see Fig. 6 [1]								
		V_{CC} = 1.8 V; C_L = 15 pF	-	6.6	9.6	-	10.9	-	11.7	ns
		V_{CC} = 1.8 V; C_L = 30 pF	-	7.7	10.8	-	12.3	-	13.3	ns
		V_{CC} = 2.5 V; C_L = 15 pF	-	4.7	6.6	-	7.5	-	8.0	ns
		V_{CC} = 2.5 V; C_L = 30 pF	-	5.4	7.4	-	8.4	-	9.1	ns
		V_{CC} = 3.3 V; C_L = 15 pF	-	3.9	5.3	-	6.0	-	6.4	ns
		V_{CC} = 3.3 V; C_L = 30 pF	-	4.4	6.0	-	6.8	-	7.3	ns
		V_{CC} = 5.0 V; C_L = 15 pF	-	3.2	4.0	-	4.5	-	4.7	ns
		V_{CC} = 5.0 V; C_L = 30 pF	-	3.7	4.5	-	5.1	-	5.4	ns
C_I	input capacitance	V_I = V_{CC} or GND; V_{CC} = 3.3 V	-	1.5	10	-	10	-	10	pF
C_O	output capacitance	V_O = V_{CC} or GND; V_{CC} = 3.3 V	-	2.5	-	-	-	-	-	pF
C_{PD}	power dissipation capacitance	per buffer; V_I = GND to V_{CC}; C_L = 30 pF; f = 10 MHz [2]								
		V_{CC} = 1.8 V	-	4.3	-	-	-	-	-	pF
		V_{CC} = 2.5 V	-	5.7	-	-	-	-	-	pF
		V_{CC} = 3.3 V	-	7.6	-	-	-	-	-	pF
		V_{CC} = 5.0 V	-	11.9	-	-	-	-	-	pF

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.

[2] C_{PD} is used to determine the dynamic power dissipation (P_D in µW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
$\sum(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

12.1. Waveforms and test circuit



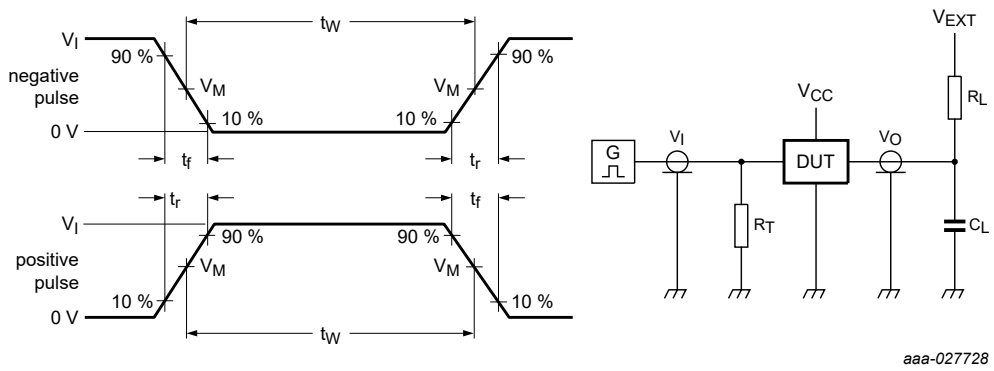
Measurement points are given in Table 9.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 6. The input A, B to output Y propagation delays

Table 9. Measurement points

Input	Output
V_M	**V_M**
0.5 × V_I	0.5 × V_{CC}



Test data is given in Table 10.

Definitions test circuit:

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;

C_L = Load capacitance including jig and probe capacitance;

R_L = Load resistance;

V_{EXT} = External voltage for measuring switching times.

Fig. 7. Test circuit for measuring switching times

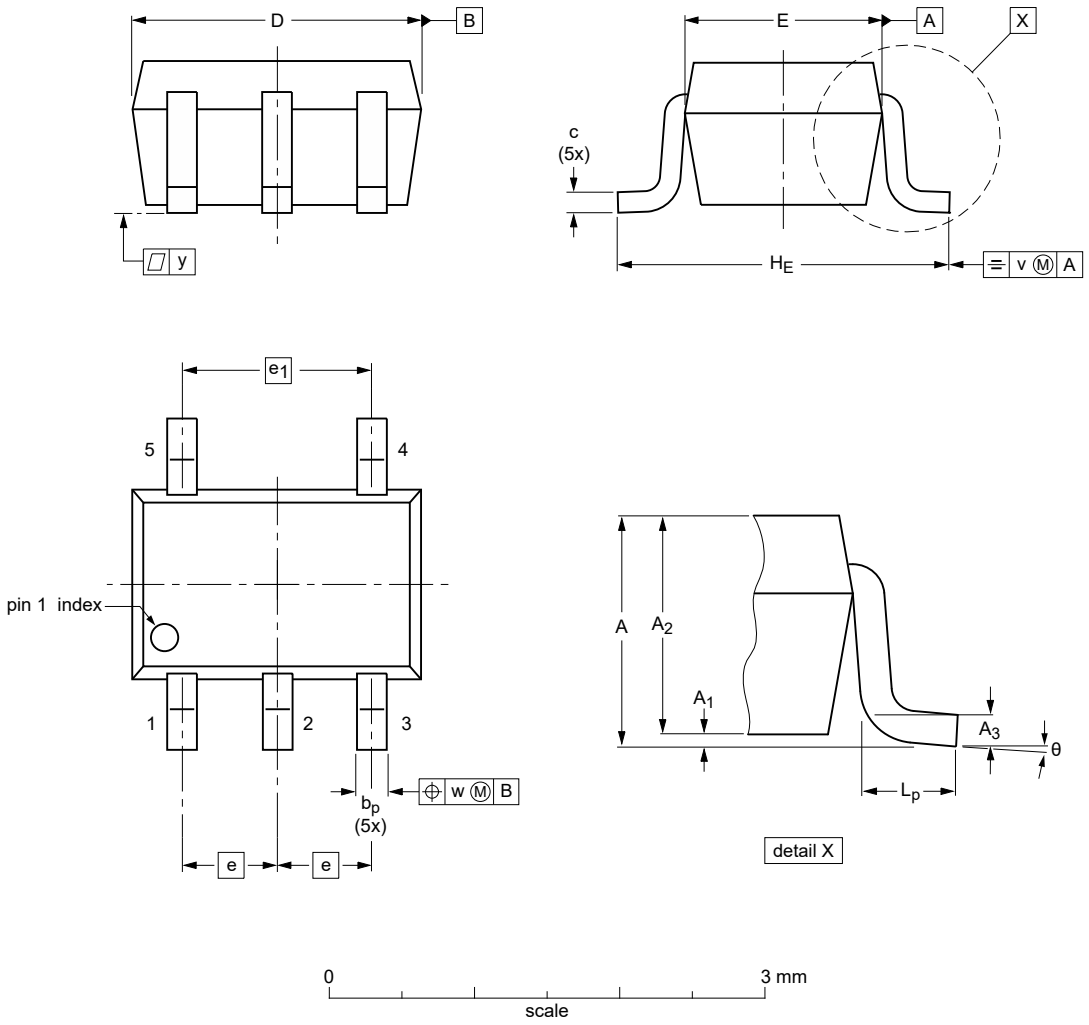
Table 10. Test data

Supply voltage	Input			Load		V_{EXT}		
V_{CC}	**V_I**	**Δt/ΔV [1]**	**f_{max}**	**C_L**	**R_L**	**t_{PLH}, t_{PHL}**	**t_{PZH}, t_{PHZ}**	**t_{PZL}, t_{PLZ}**
1.8 V	V_{CC}	≤ 1.0 ns/V	15 MHz	15 pF, 30 pF	1MΩ	GND	GND	V_{CC}
2.5 V	V_{CC}	≤ 1.0 ns/V	25 MHz	15 pF, 30 pF	1MΩ	GND	GND	V_{CC}
3.3 V	3 V	≤ 1.0 ns/V	50 MHz	15 pF, 30 pF	1MΩ	GND	GND	V_{CC}
5.0 V	3 V	≤ 1.0 ns/V	50 MHz	15 pF, 30 pF	1MΩ	GND	GND	V_{CC}

[1] dV/dt ≥ 1.0 V/ns

13. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm **SOT353-1**



Dimensions (mm are the original dimensions)

Unit		A	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	e_1	H_E	L_p	v	w	y	θ
mm	max	1.1	0.1	1.0	0.15	0.30	0.25	2.2	1.35	0.65	1.3	2.4	0.46	0.3	0.1	0.1	8°
	min	0.8	0	0.8		0.15	0.08	1.8	1.15			1.8	0.26				0°

Note

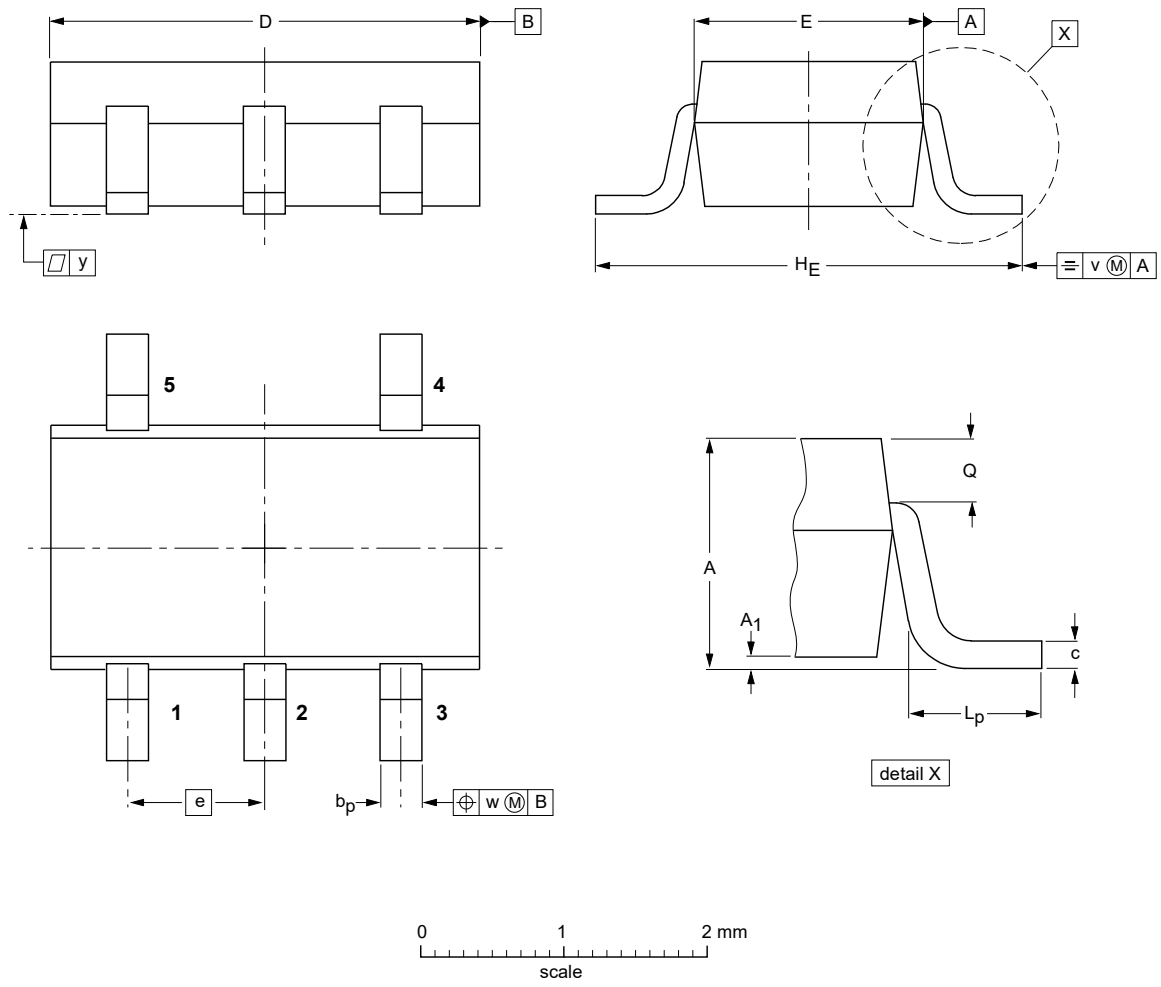
1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

sot353-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT353-1		MO-203	SC-88A			~~21-12-15~~ 21-12-16

Fig. 8. Package outline SOT353-1 (TSSOP5)

Plastic surface-mounted package; 5 leads **SOT753**



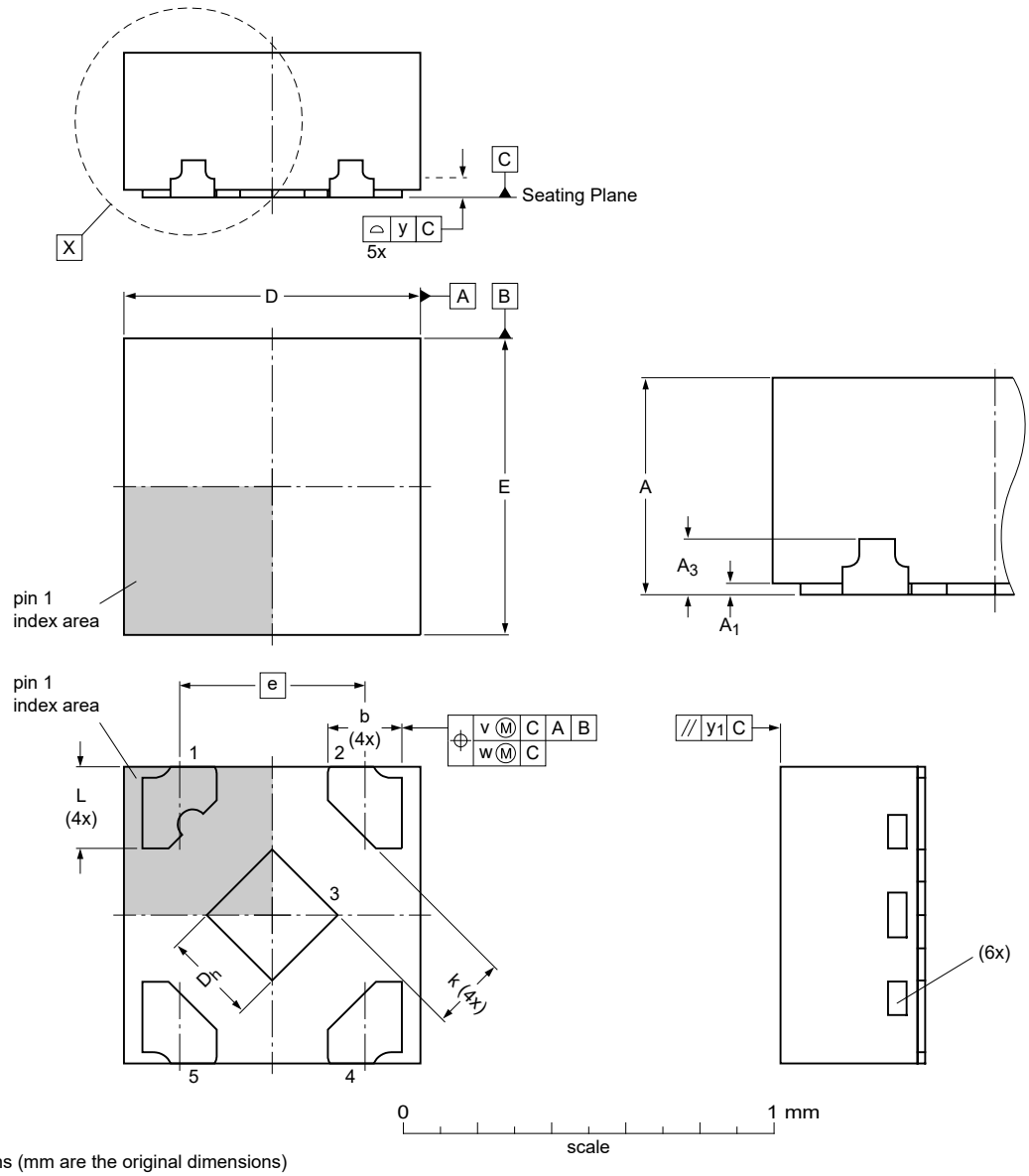
DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1	b_p	c	D	E	e	H_E	L_p	Q	v	w	y
mm	1.1 0.9	0.100 0.013	0.40 0.25	0.26 0.10	3.1 2.7	1.7 1.3	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT753			SC-74A			~~02-04-16~~ 06-03-16

Fig. 9. Package outline SOT753 (SC-74A)

X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 x 0.8 x 0.32 mm **SOT1226-3**



Dimensions (mm are the original dimensions)

Unit		A	A_1	A_3	D	D_h	E	b	e	K	L	v	w	y	y_1
mm	max	0.35	0.04	0.10 (Typ.)	0.85	0.30	0.85	0.25	0.50		0.27	0.1	0.05	0.05	0.05
	nom	0.32	0.02		0.80	0.25	0.80	0.20			0.22				
	min	0.30	0.00		0.75	0.20	0.75	0.15		0.20	0.17				

sot1226-3_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	EIAJ			
SOT1226-3		---				~~19-11-06~~ 19-11-07

Fig. 10. Package outline SOT1226-3 (X2SON5)

14. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charge Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model

15. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LV1T32 v.5	20231214	Product data sheet	-	74LV1T32 v.4
Modifications:	• Section 2: ESD specification updated according to the latest JEDEC standard.			
74LV1T32 v.4	20220223	Product data sheet	-	74LV1T32 v.3
Modifications:	• Package SOT1226 (X2SON5) changed to SOT1226-3 (X2SON5).			
74LV1T32 v.3	20220210	Product data sheet	-	74LV1T32 v.2
Modifications:	• Fig. 8: Package outline drawing for SOT353-1 (TSSOP5) has changed.			
74LV1T32 v.2	20191203	Product data sheet	-	74LV1T32 v.1
Modifications:	• Type number 74LV1T32GV (SOT753/SC-74A) added. • Table 5: Derating values for P_{tot} total power dissipation updated.			
74LV1T32 v.1	20171128	Product data sheet	-	-

16. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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